Product Preview

0.6 A 2-MHz 100% Duty Cycle Step-Down Synchronous Regulator for Automotive

The NCV890430 is a fixed-frequency Synchronous Buck regulator intended for Automotive, battery-connected applications that operate with up to a 45 V input supply. It is suitable for automotive systems with high efficiency, low noise and Low Shutdown Current requirements that also need to operate at low input voltage close to the output voltage. A reset pin (with adjustable delay) simplifies interfacing with a microcontroller. This part also features an enable input that can either be connected to a low voltage (such as a micro-controller output) or high voltage (such as the battery input), and a synchronization input.

The NCV890430 also provides several protection features expected in automotive power supply systems such as current limit, short circuit protection, and thermal shutdown. In addition, the high switching frequency produces low output voltage ripple even when using small inductor values and all-ceramic input output filter capacitors — forming a space-efficient switching regulator solution

Features

- Internal 500 m Ω P-channel and 250 m Ω N-channel Power Switches
- Capable of 100% Duty Cycle Operation
- V_{IN} Operating Range 3.5 V to 37 V
- Withstands Load Dump to 45 V
- 2 MHz Free-running Switching Frequency
- Low Shutdown Current < 10 μA
- High Voltage Enable Pin
- Synchronization Input Pin
- DC Output Current of at Least 0.6 A
- Fixed Output Voltage (5 V, 3.3 V, 2.5 V, 1.8 V Versions)
- ±2% Output Voltage Accuracy
- NCV Prefix for Automotive Requiring Site and Control Changes
- DFN Package with Wettable Flanks (Pin Edge Plating per JEDEC MO220)

Typical Applications

- Automotive Infotainment and Instrumentation
- Automotive Body Applications
- Linear Regulator Replacement
- Rear View Camera



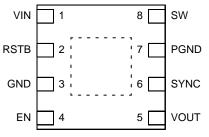
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DFN8, 3x3, 0.65P CASE 506CS

PIN CONNECTIONS



(DFN8 Top View)

MARKING DIAGRAM



XXXXX = Specific Device Code (TBD)

A = Assembly Location

L = Wafer Lot Y = Year W = Work Week ■ Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 8 of this data sheet.

This document contains information on some products that are still under development. ON Semiconductor reserves the right to change or discontinue these products without notice.

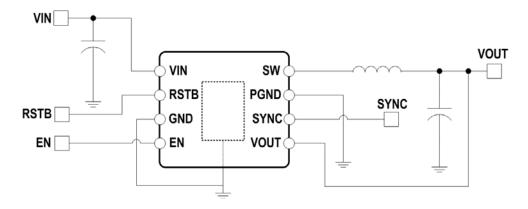


Figure 1. Typical Application Schematic

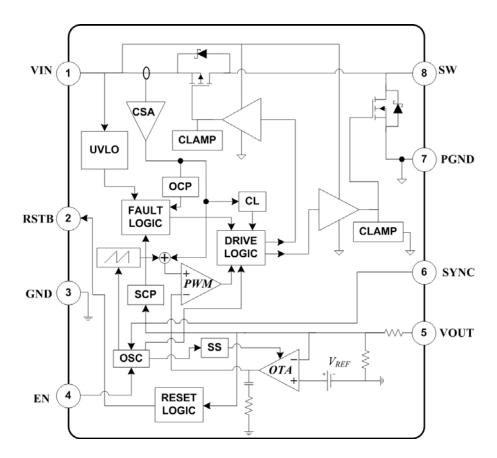


Figure 2. Simplified Block Diagram

Table 1. PIN FUNCTION DESCRIPTIONS

Pin No.	Pin Name	Description		
1	VIN	Input voltage from battery. Place an input filter capacitor in close proximity to this pin.		
2	RSTB	Reset reporting flag. Open drain output, pulling down to ground when the output voltage is out of regulation. The value of the external pull-up resistor determines the delay time that the Reset is held low.		
3	GND	Analog ground reference – should be connected directly to the output capacitor ground and the exposed pad.		
4	EN	Enable input. Connecting a "high" voltage (TTL compatible, battery voltage tolerant) to this pin turns on the regulator. A low voltage forces the part into a very low lq shutdown mode.		
5	VOUT	Output voltage sensing for regulation.		
6	SYNC	Synchronization input. Connecting an external clock to this pin synchronizes switching to the rising edge of the SYNC signal.		
7	PGND	Power ground, connect directly to the input capacitor ground and to the exposed pad.		
8	SW	Switching node of the Regulator. Connect the output inductor to this pin.		
Exposed Pad	EPAD	Must be connected to GND (pin 3, electrical ground) and to a low thermal resistance path to the ambient temperature environment		

Table 2. ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Min/Max Voltage VIN		-0.3 to 45	V
Max Voltage VIN to SW		45	V
Min/Max Voltage SW		–0.7 to 40 V	V
Min Voltage SW – 20 ns		-3.0	V
Min/Max Voltage EN		–0.3 to 40 V	V
Min/Max Voltage on SYNC, RSTB		-0.3 to 6	V
Min/Max Voltage VOUT		-0.3 to 18	V
Thermal Resistance, DFN8 Junction-to-Ambient (Note 1)	$R_{ heta JA}$	40	°C/W
Storage Temperature Range		-55 to +150	°C
Operating Junction Temperature Range	T _J	-40 to +150	°C
ESD withstand Voltage (Human Body Model)	V _{ESD}	2.0	kV
Moisture Sensitivity	MSL	Level 1	
Peak Reflow Soldering Temperature (Note 1)		260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Mounted on 1 sq. in. of a 4-layer PCB with 1 oz. copper thickness.

Table 3. ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 4.5 \text{ V to } 28 \text{ V}, \text{ EN} = 5 \text{ V}. \text{ Min/Max values are valid for the temperature range } -40^{\circ}\text{C} \le T_{J} \le 150^{\circ}\text{C}$ unless noted otherwise, and are guaranteed by test, design or statistical correlation.)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit			
QUIESCENT CURRENT									
Quiescent Current, Enabled	V _{IN} = 13.2 V	I _{qEN}			3	mA			
uiescent Current, Shutdown V _{IN} = 13.2 V, V _{EN} = 0 V, 25 °C		I _{qSD}			5	μΑ			
UNDERVOLTAGE LOCKOUT – VIN									
UVLO Start Threshold	V _{IN} Rising	V _{UVLSTT}	4.1		4.5	V			
UVLO Stop Threshold	V _{IN} Falling	V _{UVLSTP}	3.2		3.5	V			
SOFT-START				•		•			
Soft-Start Completion Time		t _{SS}	0.8	1.4	2.0	ms			
OUTPUT VOLTAGE				•		•			
Output Voltage during Regulation	100 μA < I _{OUT} < 0.6 A 5.0 V Option 3.3 V Option 2.5 V Option 1.8 V Option	V _{OUTreg}	4.9 3.234 2.45 1.764	5.0 3.3 2.5 1.8	5.1 3.366 2.55 1.836	V			
OSCILLATOR		•		!		!			
Frequency	4.5 V < V _{IN} < 18 V 20 V < V _{IN} < 28 V	f _{SW}	1.8 0.9	2.0 1.0	2.2 1.1	MHz			
VBAT OVERVOLTAGE SHUTDOWN MONIT	OR			•		•			
Overvoltage Stop Threshold		V _{OV1SP}	37		40	V			
Overvoltage Start Threshold		V _{OV1ST}	34			V			
Overvoltage Hysteresis		V _{OV1HY}	0.6		2.7	V			
VIN FREQUENCY FOLDBACK MONITOR									
Frequency Foldback Threshold	V _{IN} Rising V _{IN} Falling	V _{FLDUP} V _{FLDDN}	18.4 18		20 19.8	V			
Frequency Foldback Hysteresis		V _{FLDHY}	0.2	0.3	0.4	V			
PEAK CURRENT LIMIT									
Current Limit Threshold		I _{LIM}	1.5	1.7	1.9	Α			
Low-Side Current Limit Threshold	V _{SW} = 13.2 V	I _{LIMLS}		1.5		Α			
POWER SWITCHES									
High-Side Switch ON Resistance		R _{DSON-HS}			1000	mΩ			
Low-Side Switch ON Resistance		R _{DSON-LS}			500	mΩ			
Leakage Current V _{IN} to SW	$V_{SW} = 0, -40^{\circ}C \le T_{J} \le 85^{\circ}C$	I _{LKSWH}			10	μΑ			
Leakage Current SW to GND	$V_{SW} = 13.2 \text{ V}, -40^{\circ}\text{C} \le T_{J} \le 85^{\circ}\text{C}$	I _{LKSWL}			10	μΑ			
Minimum ON Time	Measured at SW Pin	t _{ONMIN}	45		70	ns			
Minimum OFF Time when Not 100% Duty Cycle	Measured at SW Pin at f _{SW} = 2 MHz	t _{OFFMIN}		30	50	ns			
Non-Overlap Time		t _{NOVLP}		10		ns			
SLOPE COMPENSATION									
Ramp Slope (Note 2) (With Respect to Switch Current)	4.5 V < V _{IN} < 18 V 20 V < V _{IN} < 28 V	S _{ramp} S _{ramp(HV)}	1.05 0.5	1.5 0.75	1.95 1	A/μs			

Table 3. ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = 4.5 \text{ V to } 28 \text{ V}, \text{ EN} = 5 \text{ V}. \text{ Min/Max values are valid for the temperature range } -40^{\circ}\text{C} \le T_{J} \le 150^{\circ}\text{C} \text{ unless noted otherwise,}$ and are guaranteed by test, design or statistical correlation.)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SHORT CIRCUIT FREQUENCY FOLDBACK						
Switching Frequency in Short-Circuit Condition Lowest Foldback Frequency Lowest Foldback Frequency – High V _{IN}	V _{OUT} = 0 V, 4.5 V < V _{IN} < 18 V V _{OUT} = 0 V, 20 V <v<sub>IN < 28V</v<sub>	f _{SWAF}	450 225	550 275	650 325	kHz
HICCUP MODE		3			Į	
Hiccup Mode	V _{SW} = 0 V	f _{SWHIC}	24	32	40	kHz
Hiccup Mode 2 – SW Short to Battery	V _{SW} = 13.2 V	fswhicls	24	32	40	kHz
SYNCHRONIZATION						I
SYNC Input Resistance to Ground	V _{SYNC} = 5.0 V	R _{H(SYNC)}	50		200	kΩ
SYNC Input High Threshold Voltage		V _{HSYNC}	2.0			V
SYNC Input Low Threshold Voltage		V _{LSYNC}			0.8	V
SYNC High Pulse Width	V _{SYNC} > max V _{HSYNC}	t _{HSYNC}	40			ns
SYNC Low Pulse Width	V _{SYNC} < min V _{LSYNC}	t _{LSYNC}	40			ns
External SYNC Frequency		f _{SYNC}	1.8		2.5	MHz
Master Reassertion Time	Time from Last Rising SYNC Edge to First Un-synchronized Turn-on.	t _{I(SYNC)}		650		ns
RESET				•		l
Reset Threshold	V _{OUT} Decreasing V _{OUT} Increasing	K _{RES_LO} K _{RES_HI}	90 90.5	92.5	95 97	%
Reset Hysteresis (Ratio of VOUT)		K _{RES_HYS}	0.5			%
Leakage Current into RSTB Pin					1	μΑ
Noise-Filtering Delay	From V _{OUT} < V _{RESET} to RSTB Pin Going Low	t _{RES_FILT}	10		25	μs
Reset Delay Time	I _{RSTB} = 1 mA I _{RSTB} = 500 μA I _{RSTB} = 100 μA	t _{RESET}	TBD TBD	1.0 5 25	TBD TBD	μs ms ms
Reset Delay Modes	Power Good Mode (No Delay) Delay Mode		900		600	μΑ
Reset Output Low Level	I _{RSTB} = 1 mA	V _{RESL}			0.4	V
ENABLE		•				
Logic Low Threshold Voltage		V _{ENIow}			0.8	V
Logic High Threshold Voltage		V _{ENhigh}	2			V
EN Pin Input Current		I _{ENbias}	8.0		30	μΑ
THERMAL SHUTDOWN						
Thermal Shutdown Activation Temperature (Note 2)		T _{SD}	150		190	°C
Hysteresis (Note 2)		T _{HYS}	5		20	°C
	n the Fleetrical Characteristics for the					Draduat

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Not tested in production. Limits are guaranteed by design.

TYPICAL CURVES

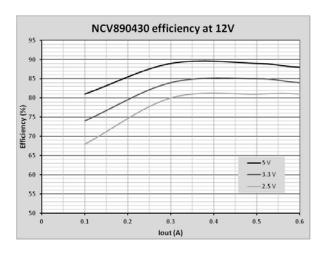


Figure 3. Typical Efficiency vs. Output Current at V_{IN} = 12 V

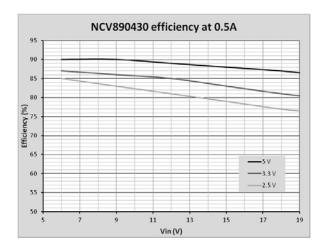


Figure 4. Typical Efficiency vs. Input Voltage at $I_{OUT} = 0.5 A$

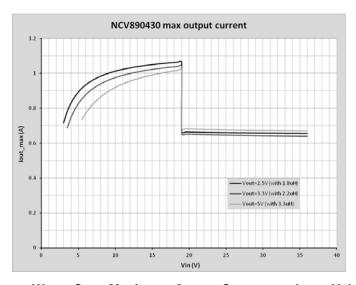


Figure 5. Worst Case Maximum Output Current vs. Input Voltage

APPLICATION INFORMATION

General Description

The NCV890430 is a high-frequency synchronous switch-mode regulator with current-mode control, fixed output voltage and fixed internal closed-loop compensation, accepting a wide input voltage range typical to automotive applications.

The use of a P-channel high-side MOSFET simplifies the driving scheme (no bootstrap circuitry needed), and enables a duty cycle of 100% for low dropout operation at low input voltage.

Input Voltage

An Undervoltage Lockout (UVLO) circuit monitors the input, and can inhibit switching and reset the soft-start circuit if there is insufficient voltage for proper regulation. Depending on the output conditions (voltage option and loading), the NCV890430 may lose regulation and run in drop-out mode before reaching the UVLO threshold: refer to the Minimum $V_{\rm IN}$ calculation tool for details. When the

input voltage drops low enough that the part cannot regulate because it reaches its maximum duty cycle, the high-side MOSFET can turn on permanently (100% duty cycle operation), to help lower the minimum voltage at which the regulator loses regulation.

An overvoltage monitoring circuit automatically terminates switching if the input voltage exceeds 37~V (see Figure 6), but the NCV890430 can withstand input voltages up to 45~V.

To avoid skipping switching pulses and enter an uncontrolled mode of operation, the switching frequency is reduced by a factor of 2 when the input voltage exceeds the $V_{\rm IN}$ Frequency Foldback threshold (see Figure 6 below). Frequency reduction is automatically terminated when the input voltage drops back below the $V_{\rm IN}$ Frequency Foldback threshold. This also helps to limit the power lost in switching and generating the drive voltage for the Power Switches at high input voltage.

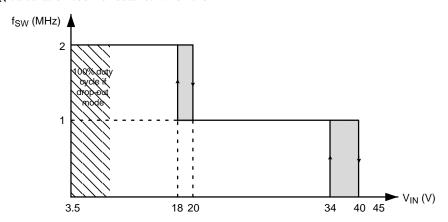


Figure 6. NCV890430 Worst-Case Switching Frequency Profile vs. Input Voltage

Soft-Start

Upon being enabled or released from a fault condition, a soft-start circuit ramps the switching regulator error amplifier reference voltage to the final value, forcing the output to follow the same soft-start ramp. During soft-start, the average switching frequency is lower until the output voltage approaches regulation.

Slope Compensation

A fixed slope compensation signal is generated internally and added to the sensed current to avoid increased output voltage ripple due to bifurcation of inductor ripple current at duty cycles above 50%. The fixed amplitude of the slope compensation signal requires the inductor to be greater than a minimum value, depending on output voltage, in order to avoid sub-harmonic oscillations. The recommended inductor value is between 1.8 and 3.3 $\mu H_{\rm s}$, although other values are possible.

Current Limiting

Due to the ripple on the inductor current, the average output current of a buck converter is lower than the peak current set point of the regulator. See "typical curves" for how the variation of inductor peak current with input voltage affects the maximum dc current the NCV890430 can deliver to a load.

Short Circuit Protection

During severe output overloads or short circuits, the NCV890430 automatically reduces its switching frequency. This creates duty cycles small enough to limit the peak current in the power components, while maintaining the ability to automatically reestablish the output voltage if the overload is removed.

In more severe short-circuit conditions where the inductor current reaches the peak current limit during the minimum on time, the regulator enters a hiccup mode that further reduces the power dissipation and protects the system.

RESET Function

The RSTB pin is pulled low when the output voltage falls below 6.5 % of the nominal regulation level, and floats when the output is properly regulated. A pull-up resistor tied to the output is needed to generate a logic high signal on this open-drain pin. The pin can be left unconnected when not used.

When the output voltage drops out of regulation, the pin goes low after a short noise-filtering delay (K_{RES_FILT}). It stays low for a delay time (adjustable) after the output goes back to regulation, simplifying the connection to a micro-controller.

The RSTB signal can either be used as a reset with delay or a power good (no delay). The delay is determined by the current into the RSTB pin, set by a resistor, as shown in Figure 7.

Use the following equation to determine the ideal reset delay time using currents less than 1 mA:

$$t_{\text{delay}} = \frac{2500}{I_{\text{RSTB}}} \tag{eq. 1}$$

where: t_{delay} is the ideal reset delay time [ms] I_{RSTB} is the current into the RSTB pin [μ A]

Using $I_{RSTB} = 1$ mA removes the delay and allows the reset to act as a "power good" pin.

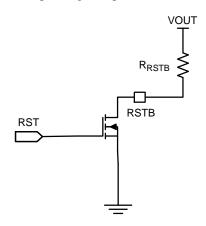


Figure 7. Reset with Adjustable Delay on a Single Pin

The RSTB resistor is commonly tied to VOUT. Depending on the output voltage option, typical delay times can be achieved with the following resistor values:

Table 4. TYPICAL DELAY TIMES

R _{RSTB} (kΩ)	t _{delay} (ms) – 5 V	t _{delay} (ms) – 3.3 V	t _{delay} (ms) – 2.5 V	t _{delay} (ms) – 1.8 V
5	-	-	5	6.9
10	5	7.6	10	14
20	10	15	20	-
30	15	23	-	-
50	25	-	-	-

Enable

The NCV890430 is designed to accept either a logic-level signal or battery voltage as an Enable signal. However, if voltages above 40 V are expected, EN should be tied to VIN through a 10 $k\Omega$ resistor in order to limit the current flowing into the overvoltage protection of the pin.

A low signal on Enable induces a shutdown mode which shuts off the regulator and minimizes its supply current to less than $5 \mu A$ by disabling all functions.

Once the switching regulator output is enabled, a soft-start is always initiated.

Thermal Shutdown

A thermal shutdown circuit inhibits switching and resets the soft-start circuit if internal temperature exceeds a safe level. Switching is automatically restored when temperature returns to a safe level.

Exposed Pad

The exposed pad (EPAD) on the back of the package must be electrically connected to both the analog and the power electrical ground GND and PGND pins for proper, noise-free operation.

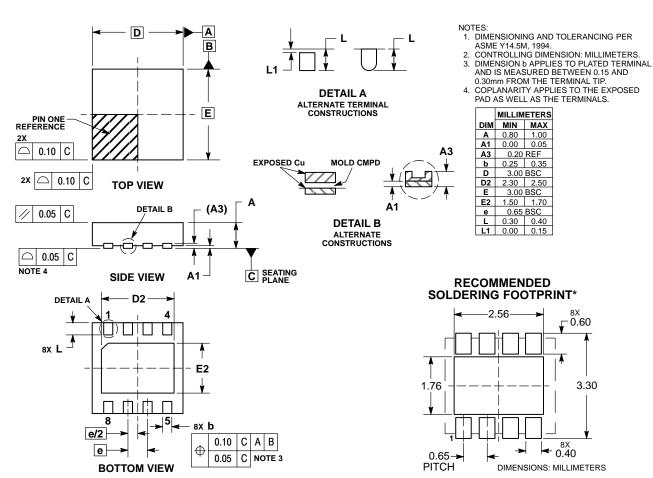
DEVICE ORDERING INFORMATION

Device	Output	Marking	Package	Shipping [†]	
NCV890430MW50TXG	5.0 V	TBD			
NCV890430MW33TXG	3.3 V	TBD	DFN8	TBD / Tape & Reel	
NCV890430MW25TXG	2.5 V	TBD	(Pb-Free)		
NCV890430MW18TXG	1.8 V	TBD			

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

DFN8, 3x3, 0.65P CASE 506CS ISSUE O



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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